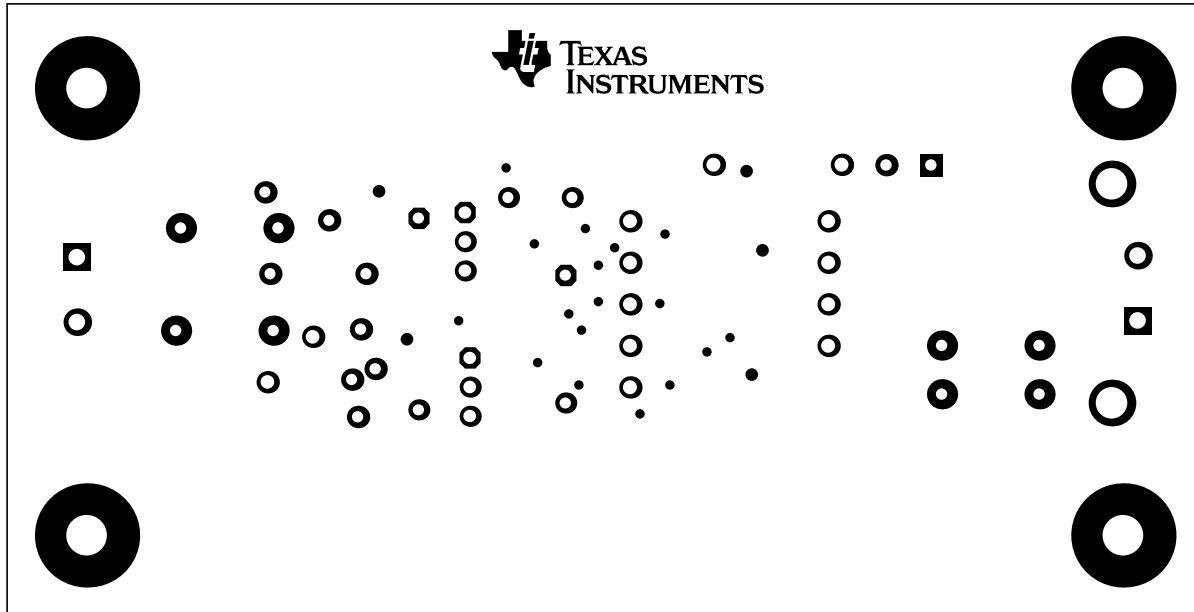
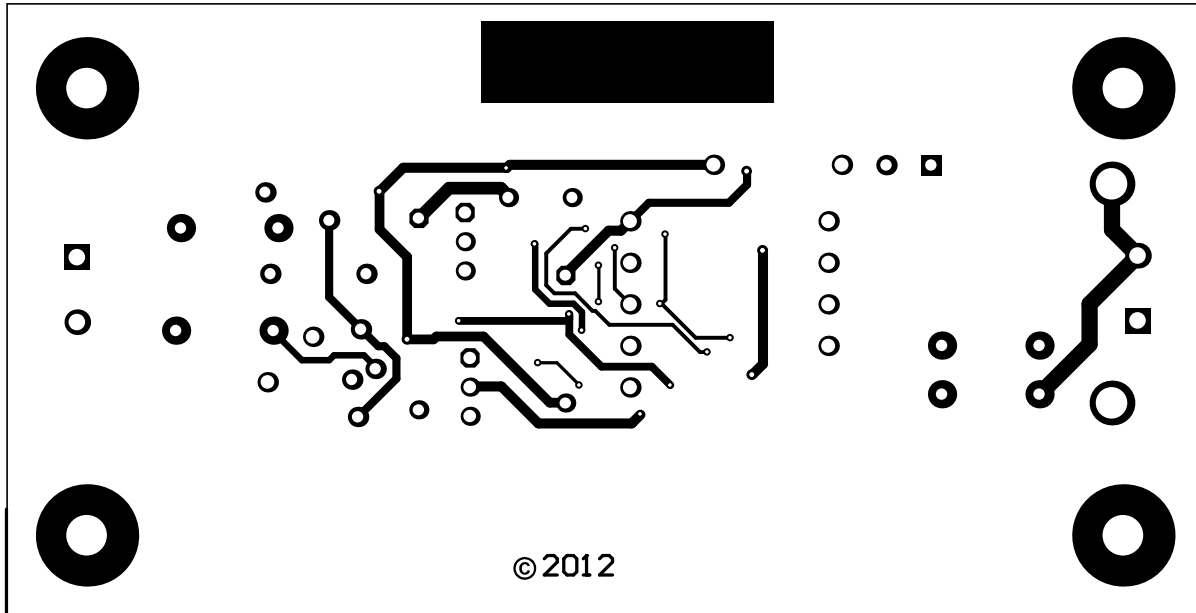


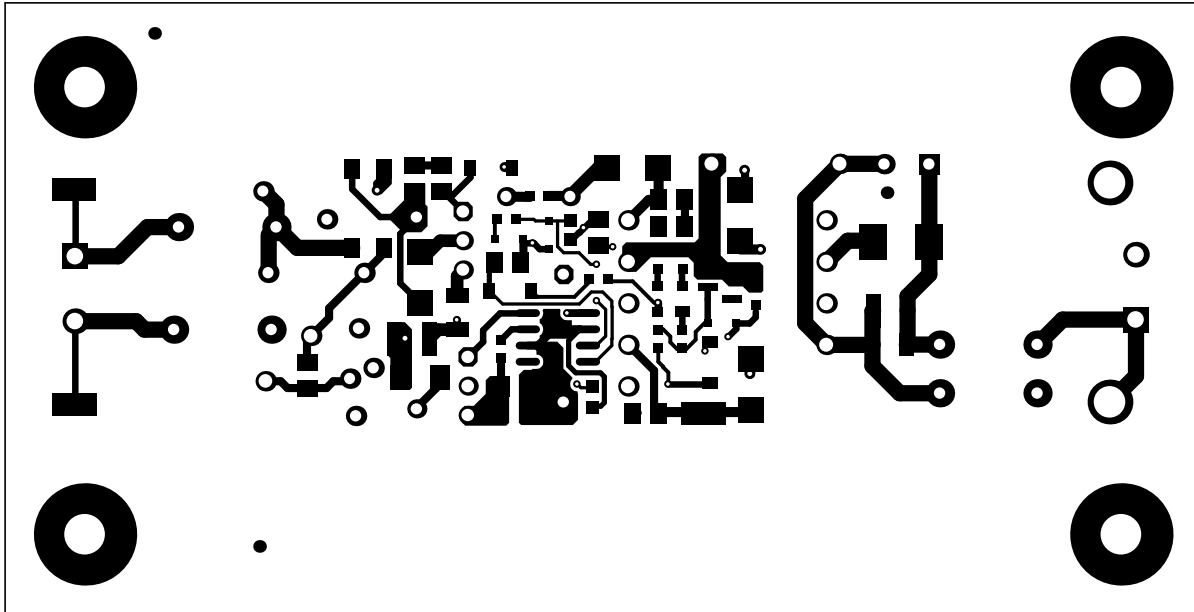
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92314-DIM		
LAYER NAME =	ARTWORK # =	00000 -001 REVA	TEXAS INSTRUMENTS
PLOT NAME = Top Overlay	GENERATED	: 7/11/2012	14:40:28



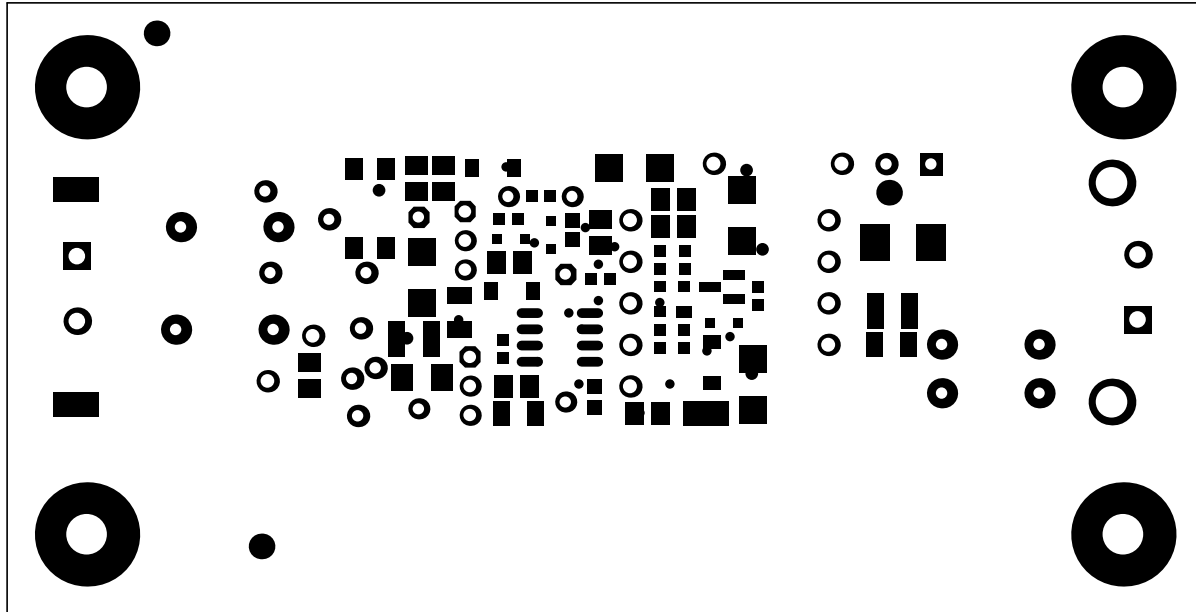
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92314-DIM		
LAYER NAME =	ARTWORK # = 00000 -001 REVA	TEXAS INSTRUMENTS	
PLOT NAME = Top Solder Mask		GENERATED	: 7/11/2012 14:40:28



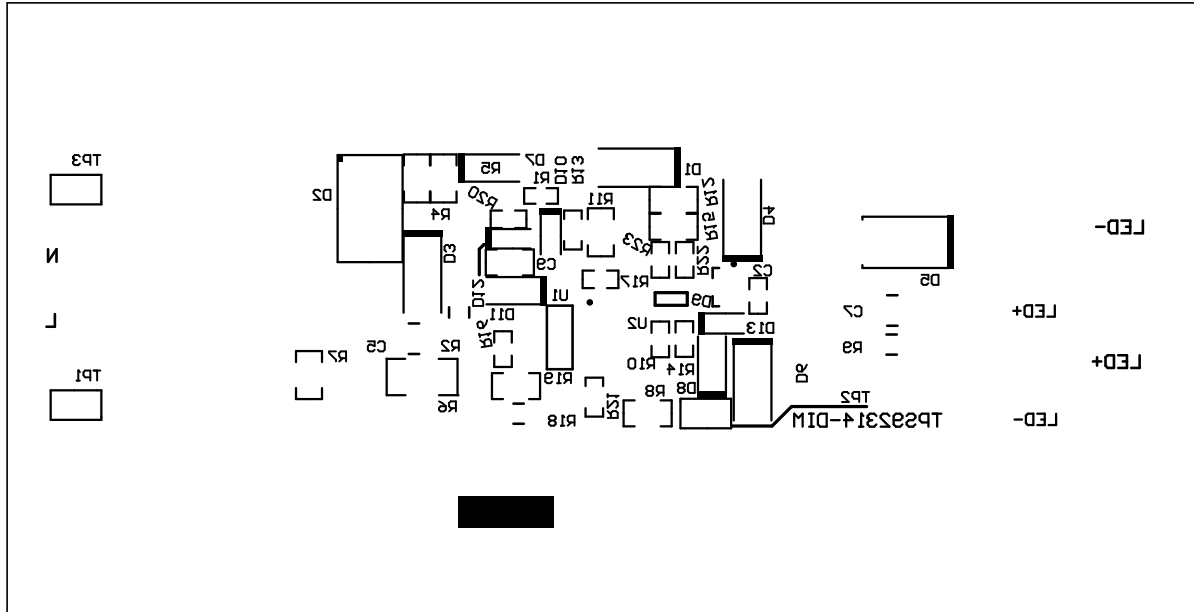
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LAYER NAME =	ARTWORK # = 00000 -001 REVA	TEXAS INSTRUMENTS	
PLOT NAME = Top Layer	GENERATED	: 7/11/2012	14:40:29



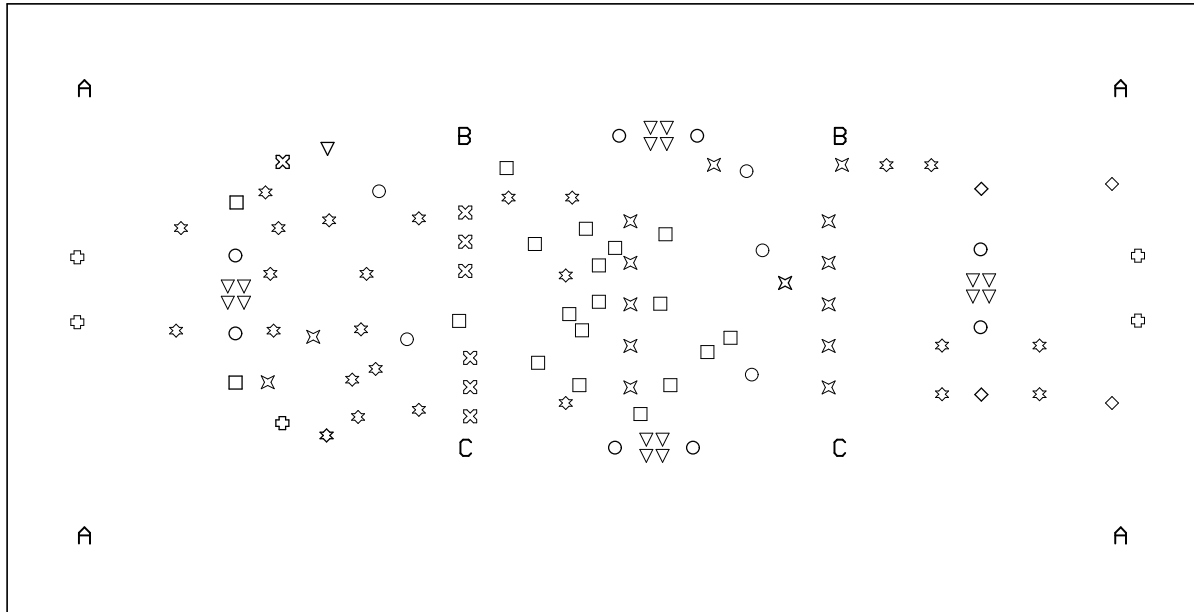
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LAYER NAME =	ARTWORK # = 00000 -001 REVA	TEXAS INSTRUMENTS	
PLOT NAME = Bottom Layer	GENERATED : 7/11/2012		14:40:29



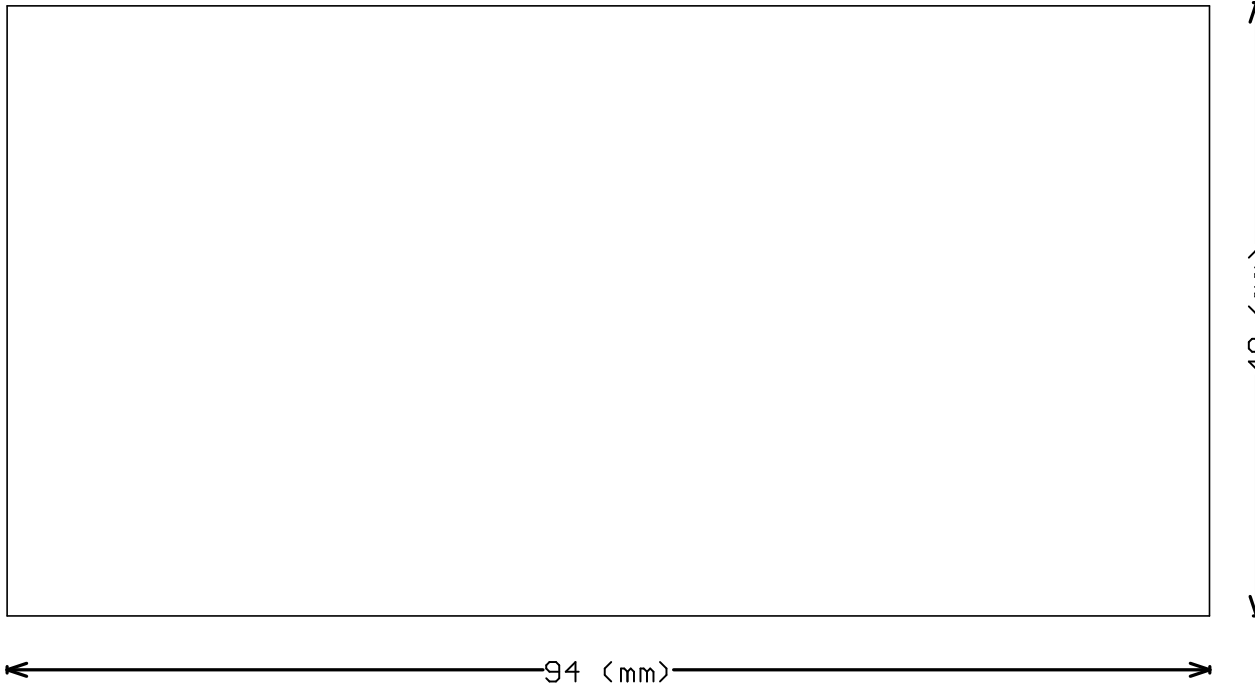
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LAYER NAME =	ARTWORK # = 00000 -001 REVA	TEXAS INSTRUMENTS	
PLOT NAME = Bottom Solder Mask		GENERATED	: 7/11/2012 14:40:30



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92314-DIM		
LAYER NAME =	ARTWORK # = 00000 -001 REVA	TEXAS INSTRUMENTS	
PLOT NAME = Bottom Overlay	GENERATED : 7/11/2012		14:40:31



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92314-DIM		
LAYER NAME =	ARTWORK # = 00000 -001 REVA	TEXAS INSTRUMENTS	
PLOT NAME = Drill Drawing		GENERATED : 7/11/2012 14:40:31	



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = TPS92314-DIM		
LAYER NAME = M2 Board Dimensions	ARTWORK # = 88000000 -001 REVA	TEXAS INSTRUMENTS	
PLOT NAME = Board Dimensions		GENERATED	: 7/11/2012 14:41:16

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